

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Dioscoro A. Merilo</td> <td>09/23/2008</td> </tr> <tr> <td>Antonio B. Dimaano Jr.</td> <td>09/23/2008</td> </tr> </tbody> </table>		Name	Execution Date	Dioscoro A. Merilo	09/23/2008	Antonio B. Dimaano Jr.	09/23/2008
Name	Execution Date						
Dioscoro A. Merilo	09/23/2008						
Antonio B. Dimaano Jr.	09/23/2008						
RECEIVING PARTY DATA							
Name:	STATS ChipPAC Ltd.						
Street Address:	10 Ang Mo Kio Street 65						
Internal Address:	#05-17/20 Techpoint						
City:	Singapore						
State/Country:	SINGAPORE						
Postal Code:	569059						
PROPERTY NUMBERS Total: 1							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12236437</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12236437		
Property Type	Number						
Application Number:	12236437						
CORRESPONDENCE DATA							
Fax Number:	(408)738-0881						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
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Correspondent Name:	LAW OFFICES OF MIKIO ISHIMARU						
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ATTORNEY DOCKET NUMBER:	27-560						
NAME OF SUBMITTER:	Mikio Ishimaru						

CH \$40.00 12236437

Total Attachments: 2
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500674050

PATENT
REEL: 021672 FRAME: 0451

Docket No.: 27-560

SC-207-241

ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

QUAD FLAT PACK IN QUAD FLAT PACK INTEGRATED CIRCUIT PACKAGE SYSTEM

for which a United States patent application has been executed on or before the date of this assignment;

WHEREAS, STATS ChipPAC Ltd., a Corporation of the Republic of Singapore, having a place of business at 10 Ang Mo Kio Street 65, #05-17/20 Techpoint, Singapore 569059, Republic of Singapore (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;

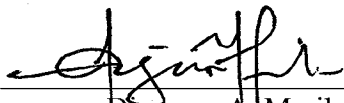
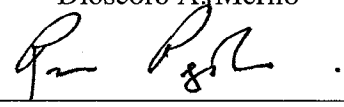

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee, the receipt of which is hereby acknowledged by said Assignor(s):

1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee where said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee.
3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

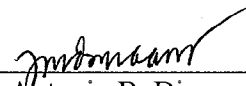
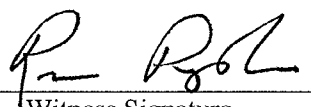

5. Said Assignor(s) hereby authorize and request the attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

Serial Number: 12/236,437 Filing Date: September 23, 2008

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

	<u>23 SEPT. 2008</u>
Dioscoro A. Merilo	Date
	
Witness Signature	Witness Signature
<u>REZA PAGAILA.</u>	<u>FREDERICK DAHILIG</u>
Print Witness Name	Print Witness Name
<u>23 SEPT. 2008.</u>	<u>23 SEPT 2008</u>
Date	Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

	<u>23 SEPT. 2008</u>
Antonio B. Dimaano Jr.	Date
	
Witness Signature	Witness Signature
<u>REZA PAGAILA.</u>	<u>FREDERICK DAHILIG</u>
Print Witness Name	Print Witness Name
<u>23 SEPT. 2008.</u>	<u>23 SEPT 2008</u>
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